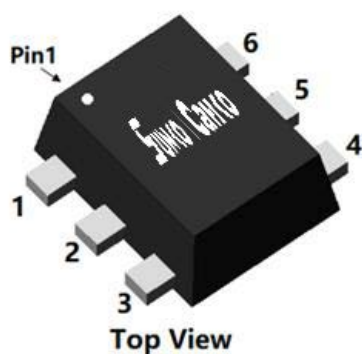
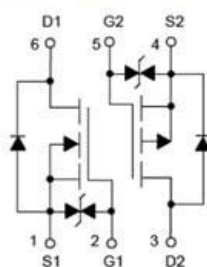
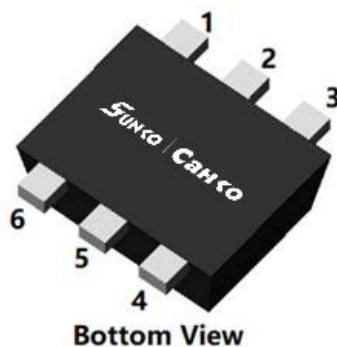


N-Channel and P-Channel Complementary MOSFET



SOT-563



Product Summary

NMOS

- V_{DS} 20V
- I_D 0.8A
- $R_{DS(ON)}$ (at $V_{GS}=4.5V$) $<300m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=2.5V$) $<400m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=1.8V$) $<950m\Omega$
- ESD Protected Up to 2.0KV (HBM)

PMOS

- V_{DS} -20V
- I_D -0.5A
- $R_{DS(ON)}$ (at $V_{GS}=-4.5V$) $<850m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=-2.5V$) $<1200m\Omega$
- $R_{DS(ON)}$ (at $V_{GS}=-1.8V$) $<2000m\Omega$
- ESD Protected Up to 2.0KV (HBM)

General Description

- Trench Power LV MOSFET technology
- High density cell design for Low $R_{DS(ON)}$
- High Speed switching
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free

Applications

- Interfacing, Logic switch
- Load switch
- Power management

■ Absolute Maximum Ratings ($T_A=25^\circ C$ unless otherwise noted)

Parameter		Symbol	NMOS	PMOS	Unit
Drain-source Voltage		V_{DS}	20	-20	V
Gate-source Voltage		V_{GS}	± 10	± 10	V
Drain Current	$T_A=25^\circ C$	I_D	0.8	-0.5	A
	$T_A=100^\circ C$		0.5	-0.3	
Pulsed Drain Current ^A		I_{DM}	3	-2	A
Total Power Dissipation ^B	$T_A=25^\circ C$	P_D	0.31	0.28	W
	$T_A=100^\circ C$		0.13	0.11	
Junction and Storage Temperature Range		T_J, T_{STG}	-55~+150	-55~+150	$^\circ C$

■ Thermal resistance

Parameter		Symbol	NMOS		PMOS		Units
			Typ	Max	Typ	Max	
Thermal Resistance Junction-to-Ambient ^C	Steady-State	$R_{\theta JA}$	335	400	365	440	$^\circ C/W$

■ Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
SCL3439KAX	F2	49A	3000	30000	120000	7" reel

SCL3439KAX

■ NMOS Electrical Characteristics (T_J=25℃ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =250μA	20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =20V, V _{GS} =0V	-	-	1	μA
		V _{DS} =20V, V _{GS} =0V, T _j =150℃	-	-	100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±10V, V _{DS} =0V	-	-	±10	μA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =250μA	0.35	0.75	1.1	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =4.5V, I _D =0.5A	-	185	300	mΩ
		V _{GS} =2.5V, I _D =0.4A	-	267	400	
		V _{GS} =1.8V, I _D =0.2A	-	438	950	
Diode Forward Voltage	V _{SD}	I _S =0.8A,V _{GS} =0V	-	-	1.2	V
Gate resistance	R _G	f=1MHz	-	37	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	0.8	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =10V,V _{GS} =0V,f=1MHZ	-	29	-	pF
Output Capacitance	C _{oss}		-	11	-	
Reverse Transfer Capacitance	C _{rss}		-	5.4	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =10V,V _{DS} =10V,I _D =0.5A	-	2.17	-	nC
Gate-Source Charge	Q _{gs}		-	0.25	-	
Gate-Drain Charge	Q _{gd}		-	0.23	-	
Reverse Recovery Charge	Q _{rr}	I _F =0.5A, di/dt=100A/us	-	0.6	-	nC
Reverse Recovery Time	t _{rr}		-	12	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =10V, V _{DS} =10V, I _D =0.5A R _{GEN} =3Ω	-	2	-	ns
Turn-on Rise Time	t _r		-	17	-	
Turn-off Delay Time	t _{D(off)}		-	14	-	
Turn-off fall Time	t _f		-	26	-	

■ PMOS Electrical Characteristics (T_J=25°C unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} = 0V, I _D =-250μA	-20	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-20V, V _{GS} =0V	-	-	-1	μA
		V _{DS} =-20V, V _{GS} =0V, T _j =150℃	-	-	-100	
Gate-Body Leakage Current	I _{GSS}	V _{GS} = ±10V, V _{DS} =0V	-	-	±10	μA
Gate Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D =-250μA	-0.35	-0.62	-1.2	V
Static Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =-4.5V, I _D =-0.5A	-	600	850	mΩ
		V _{GS} =-2.5V, I _D =-0.3A	-	850	1200	
		V _{GS} =-1.8V, I _D =-0.2A	-	1300	2000	
Diode Forward Voltage	V _{SD}	I _S =-0.5A, V _{GS} =0V	-	-	-1.2	V
Gate resistance	R _G	f=1MHz	-	75	-	Ω
Maximum Body-Diode Continuous Current	I _S		-	-	-0.5	A
Dynamic Parameters						
Input Capacitance	C _{iss}	V _{DS} =-10V, V _{GS} =0V, f=1MHz	-	37	-	pF
Output Capacitance	C _{oss}		-	12	-	
Reverse Transfer Capacitance	C _{rss}		-	6	-	
Switching Parameters						
Total Gate Charge	Q _g	V _{GS} =-10V, V _{DS} =-10V, I _D =-0.5A	-	2.55	-	nC
Gate-Source Charge	Q _{gs}		-	0.35	-	
Gate-Drain Charge	Q _{gd}		-	0.31	-	
Reverse Recovery Charge	Q _{rr}	I _F =-0.5A, di/dt=100A/us	-	1.2	-	nC
Reverse Recovery Time	t _{rr}		-	18	-	ns
Turn-on Delay Time	t _{D(on)}	V _{GS} =-10V, V _{DD} =-10V, I _D =-0.5A R _{GEN} =3Ω	-	3	-	ns
Turn-on Rise Time	t _r		-	18	-	
Turn-off Delay Time	t _{D(off)}		-	20	-	
Turn-off fall Time	t _f		-	27	-	

A. Repetitive rating; pulse width limited by max. junction temperature.

B. P_d is based on max. junction temperature, using junction-case thermal resistance.

C. The value of R_{θJA} is measured with the device mounted on 1 in² FR-4 board with 2oz. Copper, in the still air environment with T_A=25°C. The maximum allowed junction temperature of 150°C. The value in any given application depends on the user's specific board design.

■ NMOS Typical Electrical and Thermal Characteristics Diagrams

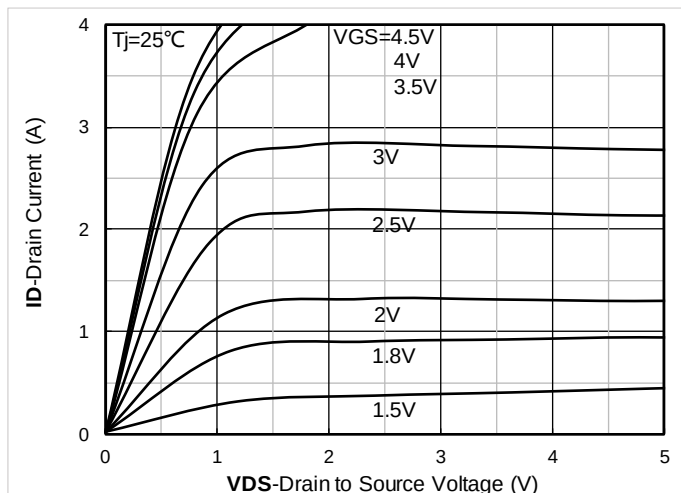


Figure 1. Output Characteristics

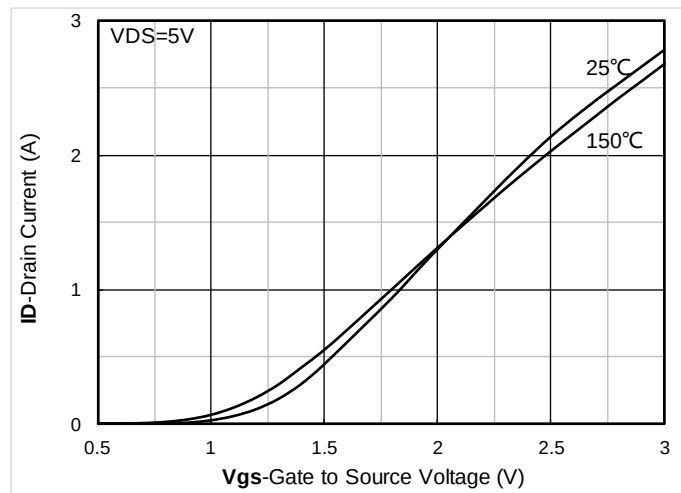


Figure 2. Transfer Characteristics

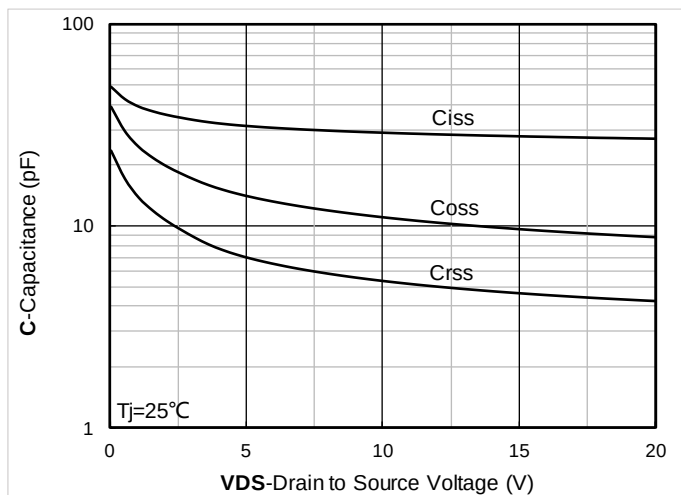


Figure 3. Capacitance Characteristics

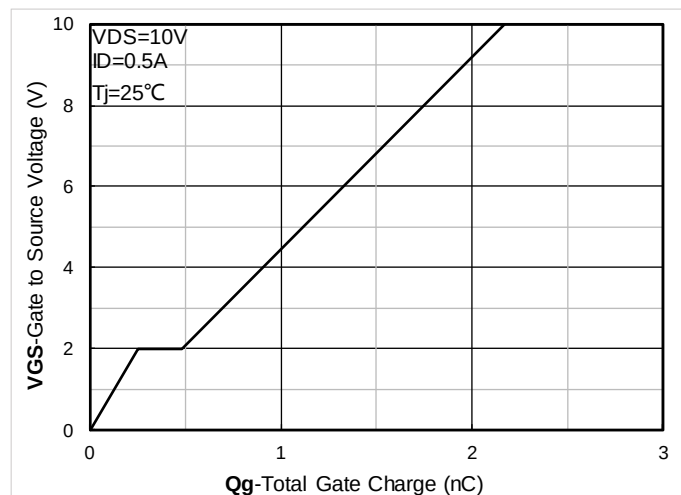


Figure 4. Gate Charge

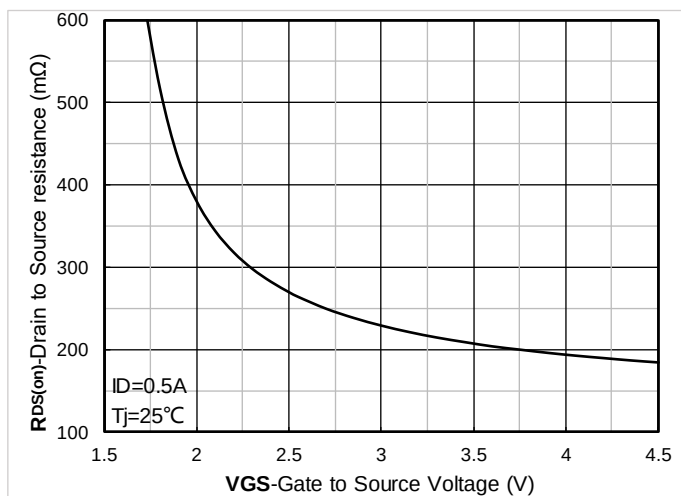


Figure 5. On-Resistance vs Gate to Source Voltage

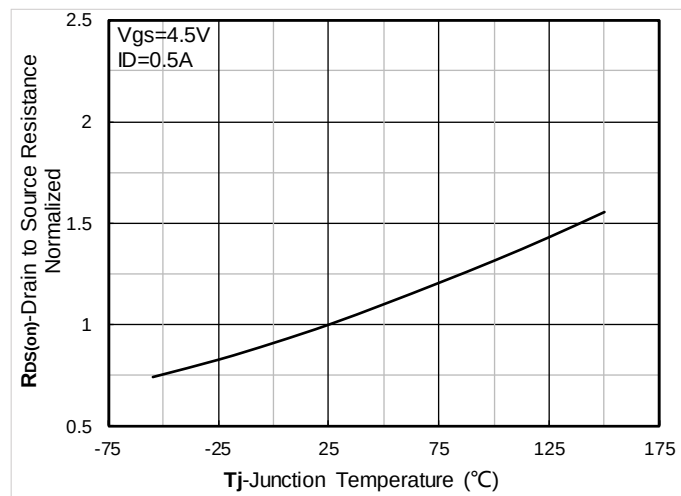


Figure 6. Normalized On-Resistance

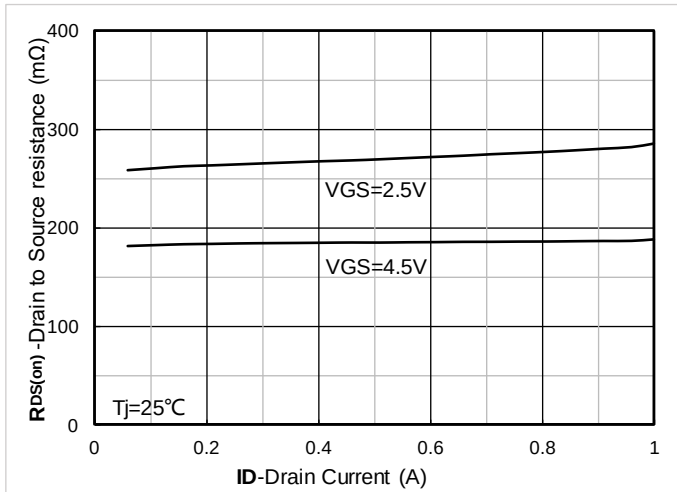


Figure 7. $R_{DS(on)}$ VS Drain Current

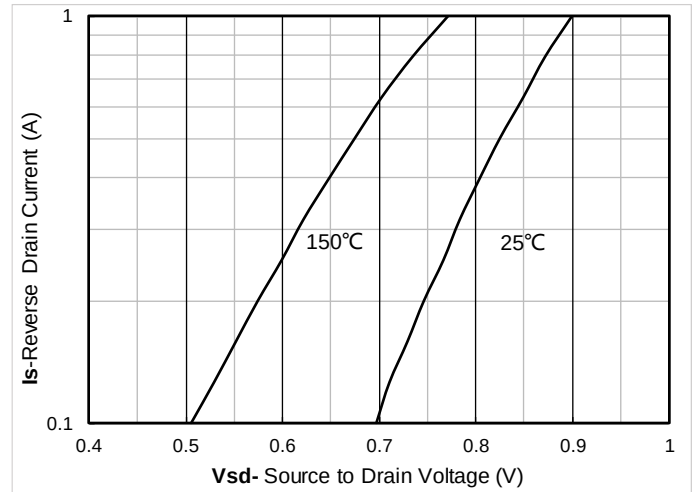


Figure 8. Forward characteristics of reverse diode

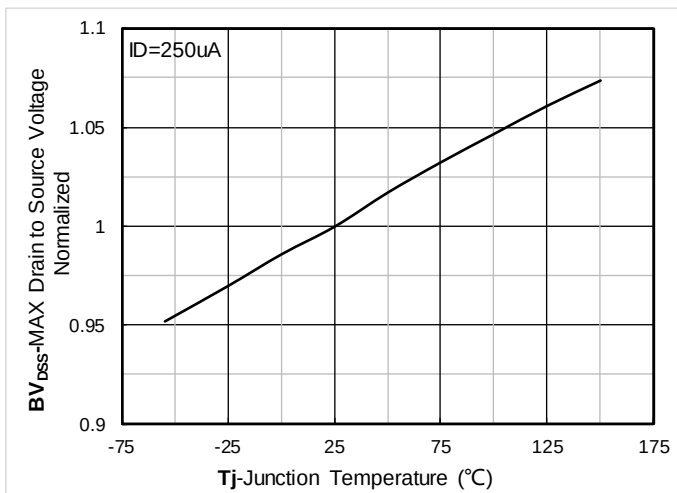


Figure 9. Normalized breakdown voltage

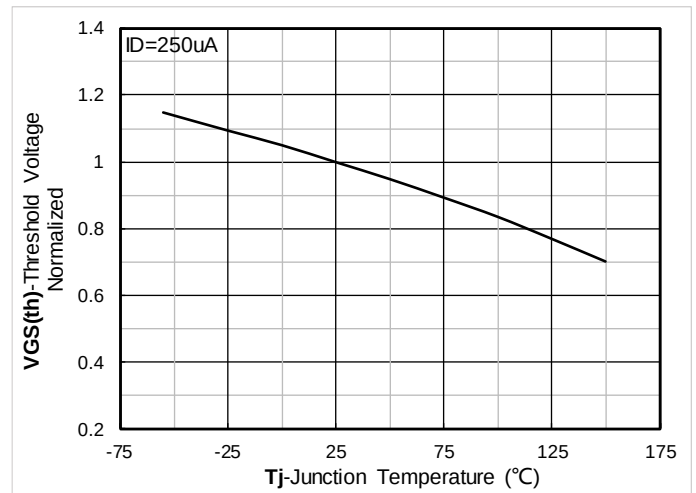


Figure 10. Normalized Threshold voltage

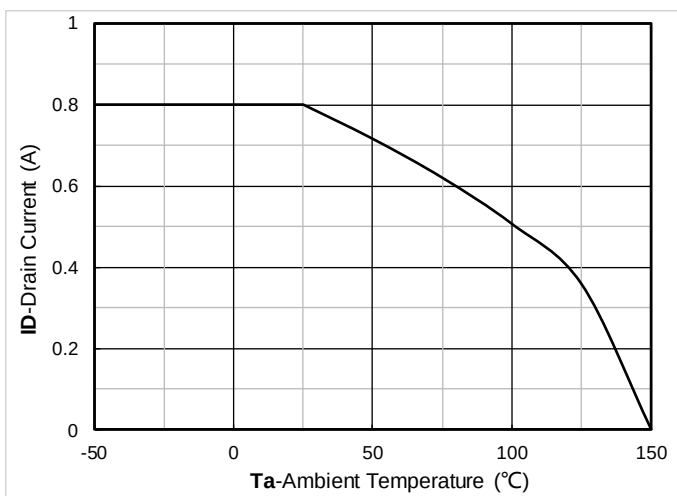


Figure 11. Current dissipation

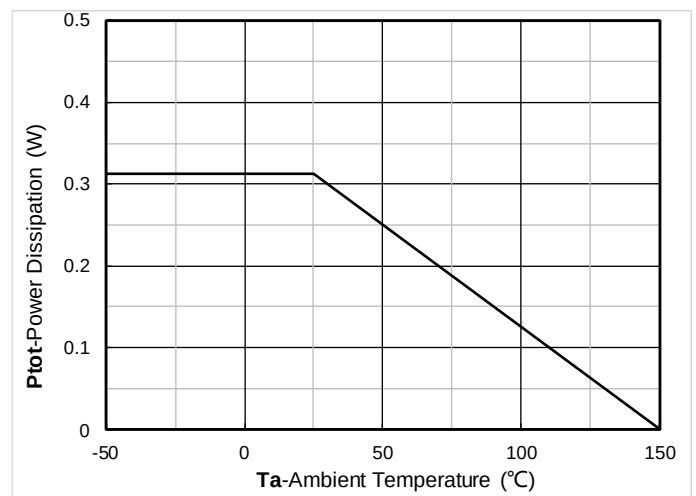


Figure 12. Power dissipation

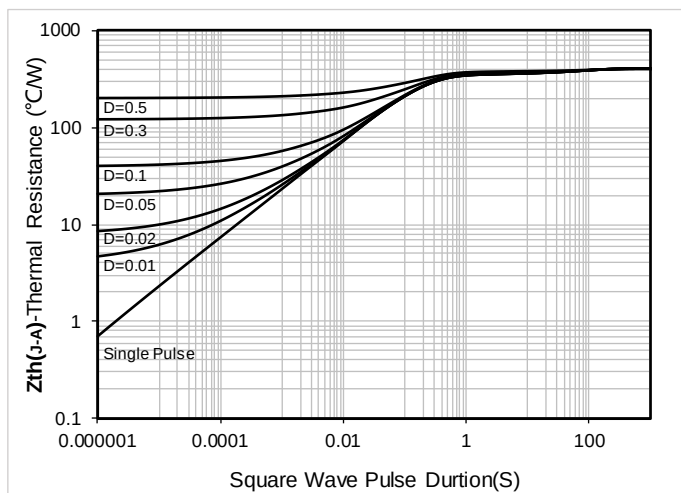


Figure 13. Maximum Transient Thermal Impedance

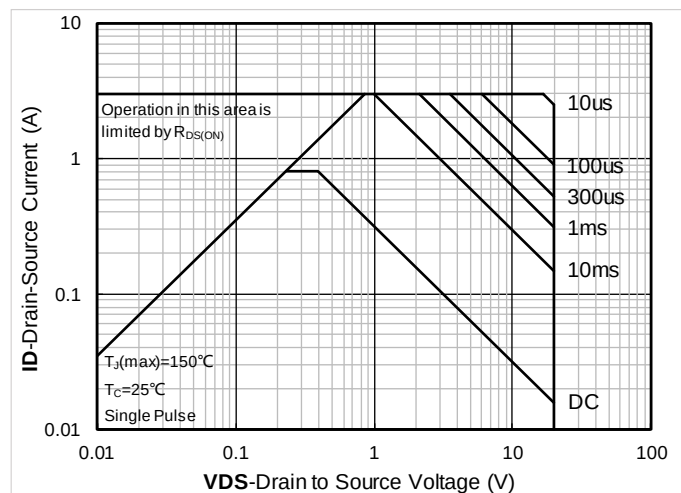


Figure 14. Safe Operation Area

PMOS Typical Electrical and Thermal Characteristics Diagrams

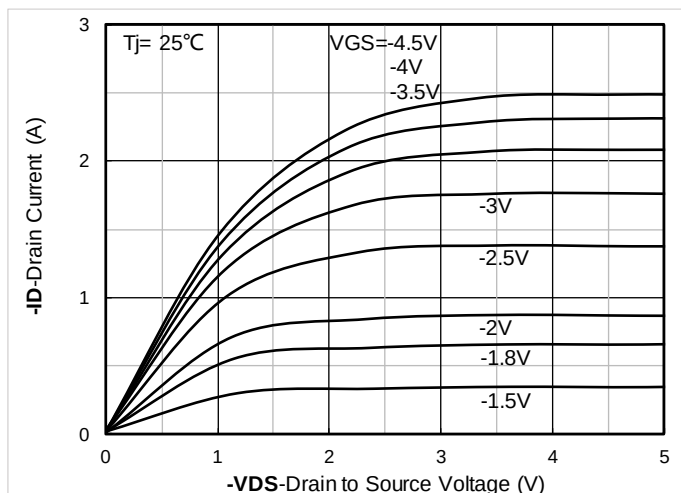


Figure 1. Output Characteristics

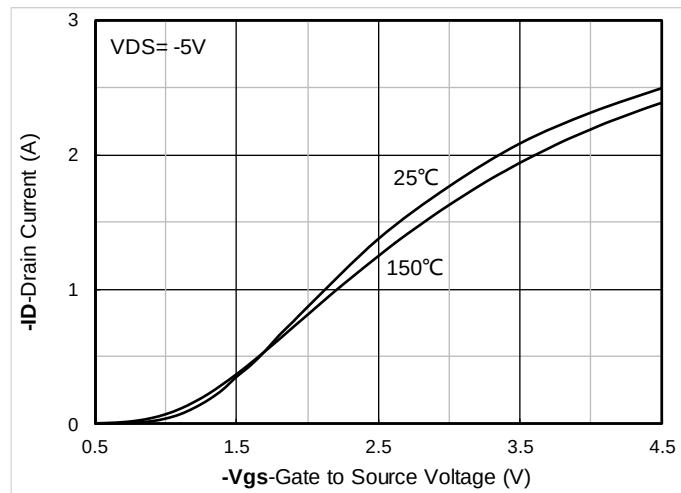


Figure 2. Transfer Characteristics

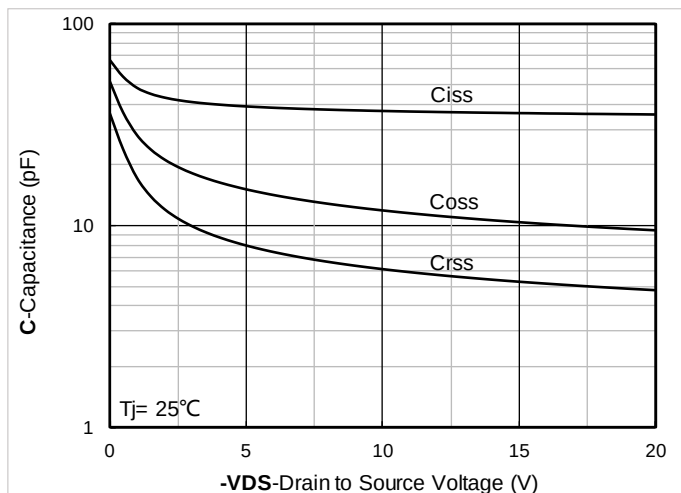


Figure 3. Capacitance Characteristics

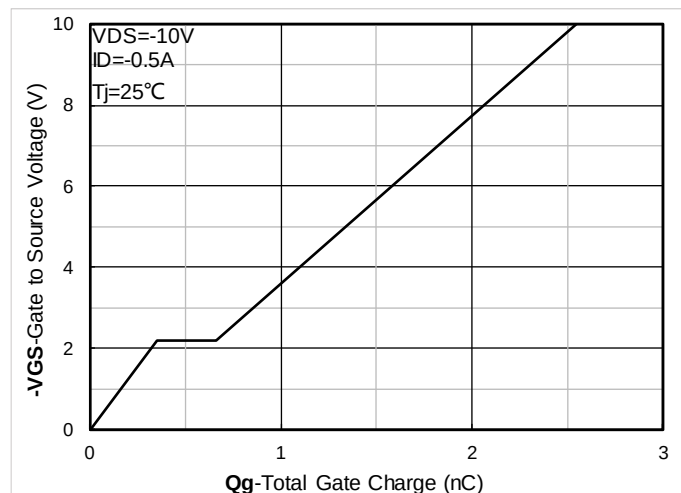


Figure 4. Gate Charge

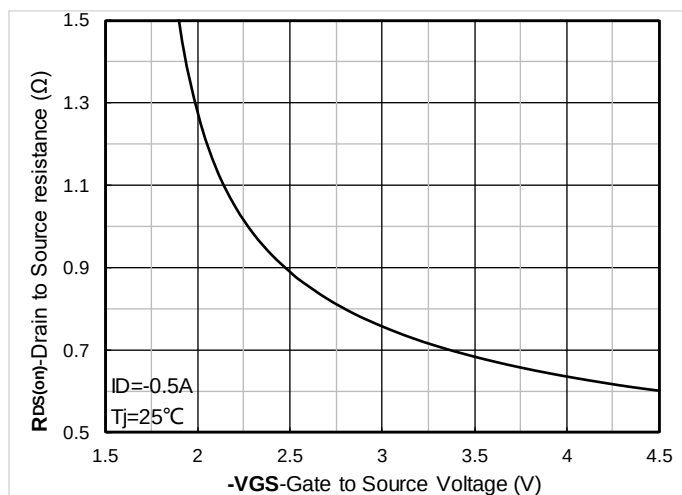


Figure 5. On-Resistance vs Gate to Source Voltage

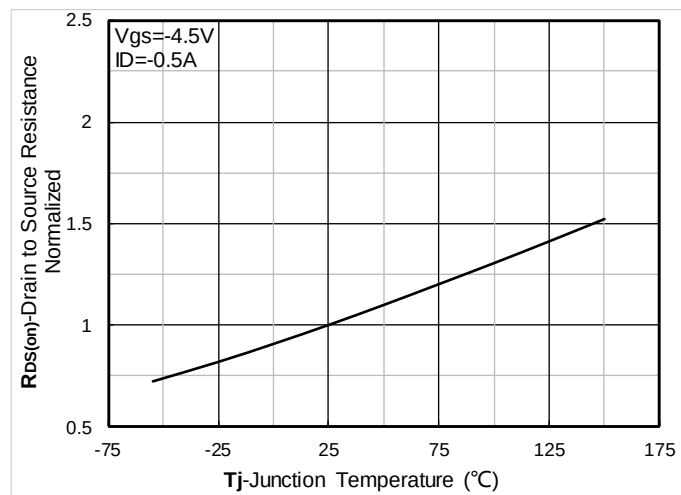


Figure 6. Normalized On-Resistance

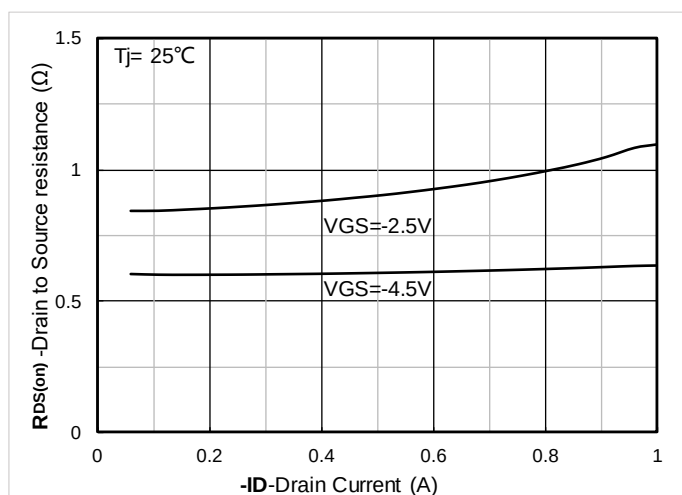


Figure 7. $R_{DS(on)}$ VS Drain Current

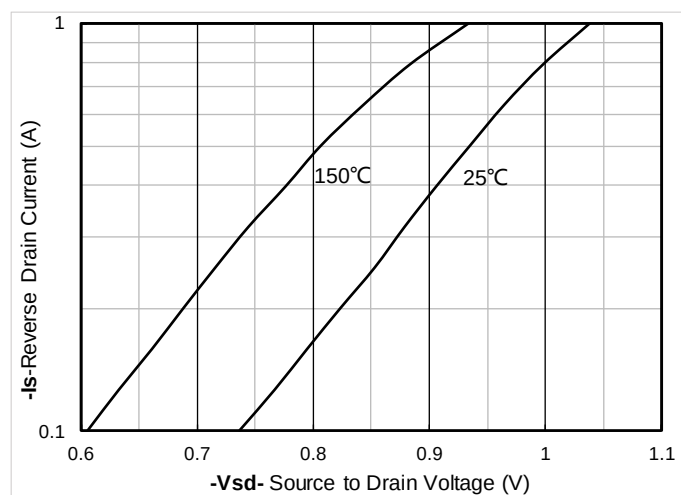


Figure 8. Forward characteristics of reverse diode

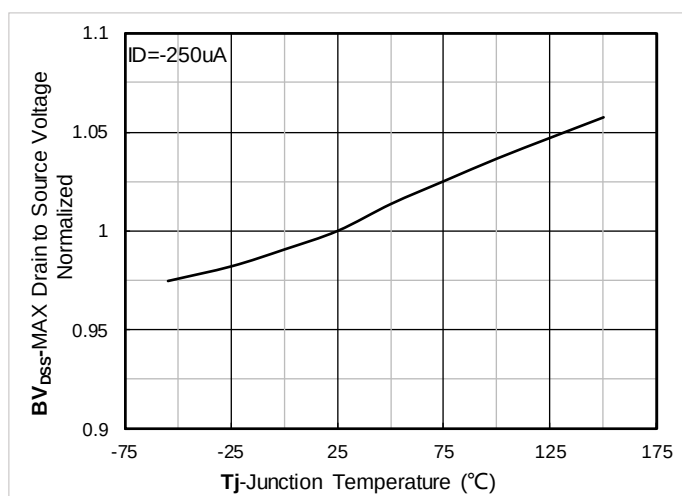


Figure 9. Normalized breakdown voltage

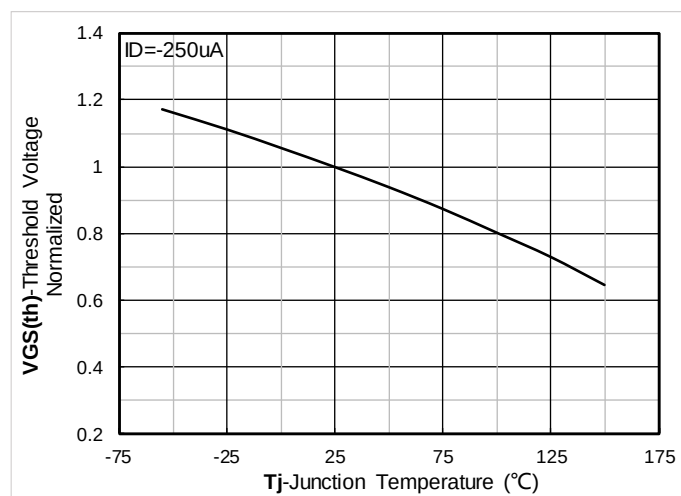


Figure 10. Normalized Threshold voltage

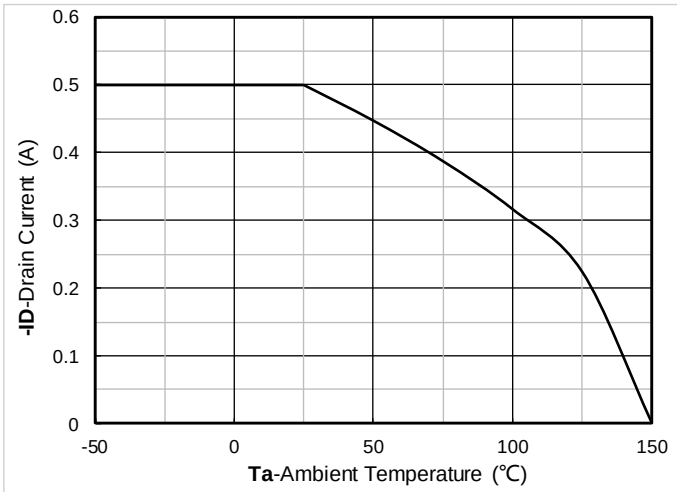


Figure 11. Current dissipation

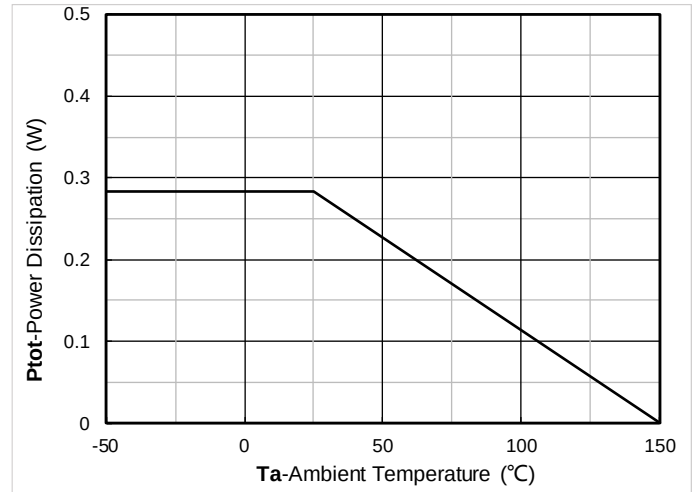


Figure 12. Power dissipation

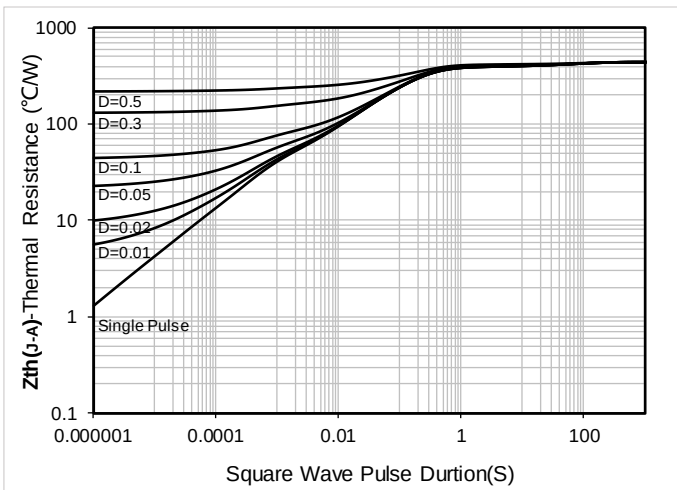


Figure 13. Maximum Transient Thermal Impedance

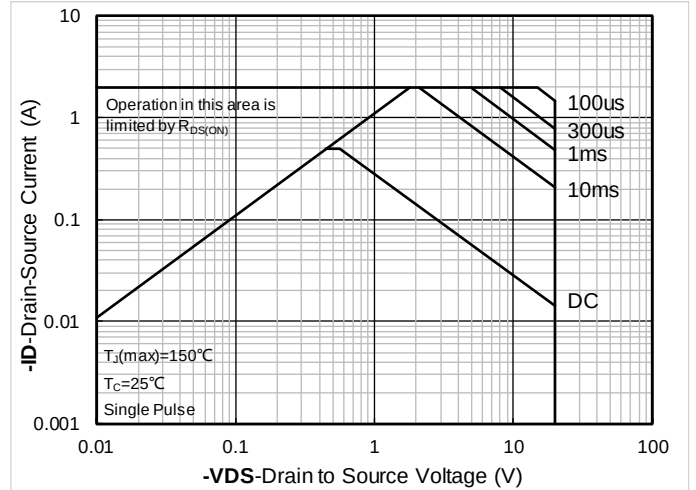
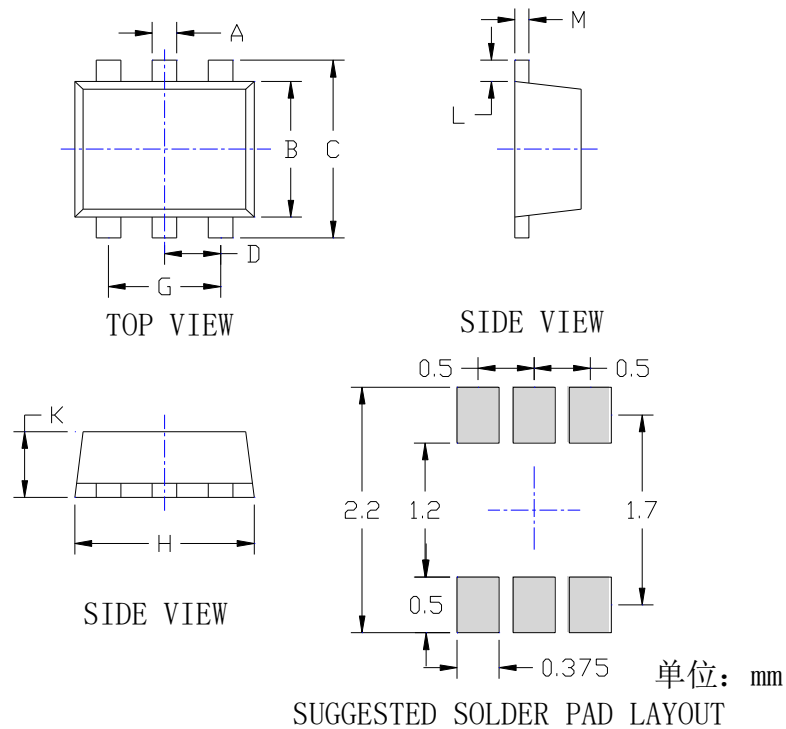


Figure 14. Safe Operation Area

■ SOT-563 Package information



SYMBOL	DIMENSIONS			
	INCHES		Millimeter	
	MIN.	MAX.	MIN.	MAX.
A	0.006	0.011	0.150	0.300
B	0.043	0.051	1.100	1.300
C	0.059	0.067	1.500	1.700
D	0.016	0.024	0.400	0.600
G	0.035	0.043	0.900	1.100
H	0.059	0.067	1.500	1.700
K	0.021	0.026	0.550	0.650
L	0.004	0.011	0.100	0.300
M	0.004	0.007	0.100	0.180

NOTE:
 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

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